

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



**Industrial networks – Profiles –  
Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 –  
CPF 3**

**Réseaux industriels – Profils –  
Partie 2-3: Profils de bus de terrain supplémentaires pour les réseaux en temps  
réel fondés sur l'ISO/IEC/IEEE 8802-3 – CPF 3**



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## CONTENTS

FOREWORD.....	8
INTRODUCTION.....	10
1 Scope.....	11
2 Normative references .....	11
3 Terms, definitions, abbreviated terms, acronyms, symbols and conventions .....	13
3.1 Terms and definitions.....	13
3.2 Abbreviated terms and acronyms .....	13
3.3 Symbols.....	15
3.4 Conventions.....	15
4 CPF 3 (PROFIBUS & PROFINET) – RTE communication profiles .....	16
4.1 General.....	16
4.2 Common .....	20
4.2.1 Administrative numbers .....	20
4.2.2 Node Classes .....	21
4.2.3 Application classes .....	25
4.2.4 Communication classes .....	31
4.2.5 Void.....	36
4.2.6 Protocol and timing parameters .....	36
4.2.7 Media redundancy classes.....	50
4.2.8 Media classes.....	52
4.2.9 Records.....	52
4.2.10 Communication feature list .....	62
4.3 Conformance class behaviors .....	63
4.3.1 General .....	63
4.3.2 IO controller, IO device, IO supervisor and Network Management Entity .....	64
4.3.3 End station component .....	65
4.3.4 Bridge component.....	74
4.3.5 Network components .....	80
4.3.6 Interconnect.....	81
4.4 Profile 3/4 .....	82
4.4.1 Physical layer.....	82
4.4.2 Data link layer .....	82
4.4.3 Application layer.....	83
4.4.4 Performance indicator selection.....	92
4.5 Profile 3/5 .....	99
4.5.1 Physical layer .....	99
4.5.2 Data link layer .....	99
4.5.3 Application layer.....	100
4.5.4 Performance indicator selection.....	108
4.6 Profile 3/6 .....	110
4.6.1 Physical layer .....	110
4.6.2 Data link layer .....	110
4.6.3 Application layer.....	110
4.6.4 Performance indicator selection.....	118
4.7 Profile 3/7 .....	122
4.7.1 Physical layer .....	122
4.7.2 Data link layer .....	122

4.7.3	Application layer .....	122
4.7.4	Performance indicator selection .....	130
4.8	Additional information .....	133
Annex A (informative)	CPF 3 (PROFINET) – Performance Indicator calculation .....	134
A.1	Application Scenario .....	134
A.2	Structural examples used for calculation .....	134
A.2.1	CP 3/4 .....	134
A.2.2	CP 3/5 .....	136
A.2.3	CP 3/6 .....	137
A.2.4	CP 3/7 .....	143
A.3	Principles used for calculation .....	133
A.3.1	General .....	143
A.3.2	Stack traversal time .....	143
A.3.3	Bridge structure .....	143
Bibliography	.....	146
Figure 1	– Conformance class model .....	17
Figure 2	– End station and bridge systems .....	17
Figure 3	– Bridge as network component .....	18
Figure 4	– End station with wireless .....	18
Figure 5	– Network component with wireless .....	19
Figure 6	– Hierarchical conformance class model .....	19
Figure 7	– Hierarchical conformance class model – with integrated bridge component .....	20
Figure 8	– Hierarchical conformance class model – network component .....	20
Figure 9	– Example of network topology using CP 3/4, CP 3/5, and CP 3/6 components .....	81
Figure 10	– Example of network topology using CP 3/4, CP 3/5, CP 3/6 and CP 3/7 components .....	82
Figure 11	– Example of network topology with wireless segment .....	85
Figure 12	– Calculation basis for delivery time and throughput RTE .....	95
Figure A.1	– CP 3/4: Example of line structure .....	134
Figure A.2	– CP 3/4: Example of ring structure .....	135
Figure A.3	– CP 3/4: Example of a wireless segment .....	135
Figure A.4	– CP 3/4: Example of an integrated wireless client .....	136
Figure A.5	– CP 3/5: Example of line structure .....	136
Figure A.6	– CP 3/5: Example of ring structure .....	137
Figure A.7	– CP 3/6: Example of line structure .....	138
Figure A.8	– CP 3/6: Example of line structure .....	139
Figure A.9	– CP 3/6: Example of ring structure .....	140
Figure A.10	– CP 3/6: Example of tree structure .....	141
Figure A.11	– CP 3/6: Example of comb structure .....	142
Figure A.12	– CP 3/6: Example of comb structure (optional) .....	143
Figure A.13	– Definition of bridge delay .....	144
Table 1	– CPF 3 symbols .....	15
Table 2	– Administrative numbers assignment .....	21

Table 3 – Node Classes and assigned Traffic Classes .....	22
Table 4 – Maximum diagnosis data for one submodule .....	22
Table 5 – Maximum storage delay.....	23
Table 6 – Reporting system minimum storage size.....	23
Table 7 – Reporting system storage.....	23
Table 8 – Reporting system Timeouts .....	24
Table 9 – Maximum storage delay.....	25
Table 10 – NME requirements.....	25
Table 11 – Application classes applicable in conformance classes for IO device and IO controller .....	26
Table 12 – Application classes applicable in conformance classes for network components .....	26
Table 13 – Application class "isochronous application" AL service selection .....	26
Table 14 – Application class "isochronous application" AL protocol selection component.....	27
Table 15 – Application class "high availability" AL service selection.....	27
Table 16 – Application class "high availability" AL protocol selection component .....	27
Table 17 – Basis application class for "process automation" .....	28
Table 18 – Application class "process automation" AL service selection .....	28
Table 19 – Application class "process automation" AL protocol selection component .....	28
Table 20 – Application class "High performance" features supported .....	29
Table 21 – Application class "High performance" parameter values .....	29
Table 22 – Application class "Controller to Controller" features supported .....	29
Table 23 – Application class "Functional safety" features supported by IO device .....	30
Table 24 – Application class "Functional safety" features supported by IO controller.....	30
Table 25 – Application class "Energy saving" AL service selection.....	31
Table 26 – Application class "Energy saving" features supported by IO device .....	31
Table 27 – Application class "Energy saving" features supported by IO controller .....	31
Table 28 – Communication classes applicable in conformance classes.....	32
Table 29 – Communication performance parameters .....	32
Table 30 – FrameSendOffset deviation for RT_CLASS_1 / RT_CLASS_UDP .....	33
Table 31 – FrameSendOffset deviation for RT_CLASS_1 / RT_CLASS_UDP certification.....	33
Table 32 – FrameSendOffset deviation factors – SendListControl .....	34
Table 33 – FrameSendOffset deviation factors – PHY.....	34
Table 34 – FrameSendOffset deviation .....	34
Table 35 – Minimum FrameSendOffset .....	35
Table 36 – FrameSendOffset deviation .....	35
Table 37 – Parameters for RT_CLASS_3 bridges.....	35
Table 38 – PTCP control loop .....	36
Table 39 – IEEE Std 802.1AS-2020 control loop .....	36
Table 40 – Maximum frame size.....	36
Table 41 – IP layer parameters for IO controller.....	37
Table 42 – IP layer parameters for IO device .....	37

Table 43 – Timeout values for name resolution .....	37
Table 44 – Values for hello request deviation.....	37
Table 45 – DCP Identify responder resources .....	38
Table 46 – DCP access control.....	38
Table 47 – DCP Identify pruning support.....	38
Table 48 – Maximum time values for MRP for 10 Mbit/s and for $\geq 100$ Mbit/s .....	38
Table 49 – Maximum packet size for MRP .....	39
Table 50 – Maximum time values for PTCP.....	39
Table 51 – Precision of timers used for PTCP.....	39
Table 52 – Maximum time values .....	40
Table 53 – Maximum deviation values for Global Time.....	40
Table 54 – Maximum deviation values for Working Clock .....	40
Table 55 – Maximum time values for LLDP .....	41
Table 56 – Required RPC resources .....	42
Table 57 – Required RPCActivityUUID resources .....	42
Table 58 – Number of ImplicitARs.....	42
Table 59 – RTA Timeout deviation .....	42
Table 60 – Required receive resources .....	43
Table 61 – Number of LogBookData entries.....	43
Table 62 – Recommended out of the box default .....	43
Table 63 – CIMSNMPAdjust.....	43
Table 64 – Community name, default values .....	44
Table 65 – SNMP timeout values .....	44
Table 66 – MIB objects update time values .....	44
Table 67 – DHCP client.....	44
Table 68 – High Availability times .....	45
Table 69 – Address parameter .....	45
Table 70 – AR Parameters .....	46
Table 71 – PDEV parameters.....	47
Table 72 – Reaction time for an IO device .....	48
Table 73 – Data Hold time deviation .....	49
Table 74 – Expected PHY delay.....	50
Table 75 – Expected Bridge delay.....	50
Table 76 – Media redundancy class applicable in conformance classes .....	51
Table 77 – Media redundancy – additional forwarding rules .....	51
Table 78 – Media redundancy startup mode.....	52
Table 79 – Version controlled "Read Record".....	52
Table 80 – Index (user specific) .....	53
Table 81 – Index (subslot specific).....	53
Table 82 – Index (slot specific) .....	56
Table 83 – Index (AR specific) .....	57
Table 84 – Index (API specific) .....	58
Table 85 – Index (device specific).....	59

Table 86 – PDPortDataAdjust (sub blocks) .....	61
Table 87 – PDPortDataCheck (sub blocks) .....	62
Table 88 – Communication feature list .....	62
Table 89 – IO controller, IO device, IO supervisor and Network Management Entity.....	63
Table 90 – Network Component .....	64
Table 91 – Conformance class behaviors .....	64
Table 92 – Node classes .....	65
Table 93 – Link speed dependent local injection per Ethernet interface .....	65
Table 94 – SNMP feature selection .....	66
Table 95 – IETF RFC 1213-MIB (MIB-2) objects .....	67
Table 96 – LLDP-MIB objects – range 1 .....	67
Table 97 – LLDP-MIB objects – range 2 .....	68
Table 98 – LLDP-MIB objects – range 3 .....	68
Table 99 – LLDP-EXT-PNO-MIB objects – range 1 .....	69
Table 100 – LLDP-EXT-PNO-MIB objects – range 2 .....	69
Table 101 – LLDP-EXT-DOT3-MIB objects – range 1 .....	69
Table 102 – LLDP-EXT-DOT3-MIB objects – range 2 .....	69
Table 103 – IEEE 802.1Q-BRIDGE-MIB objects .....	70
Table 104 – NETCONF feature selection .....	70
Table 105 – IEEE Std 802.3-2018 feature selection .....	71
Table 106 – IEEE Std 802.1Q-2018 feature selection .....	71
Table 107 – Node classes for bridge .....	74
Table 108 – Supported concurrent Link Speed for bridges .....	74
Table 109 – IEEE Std 802.1Q-2018 bridge components for Conformance Class D .....	74
Table 110 – IEC 61784-5-3 feature selection .....	75
Table 111 – IEC 62439-2 feature selection .....	75
Table 112 – Buffering capacity per port.....	76
Table 113 – Special case: buffering capacity for eight and more ports .....	76
Table 114 – IEEE Std 802.1AB-2016 feature selection.....	77
Table 115 – IEEE Std 802.1AS-2020 feature selection.....	77
Table 116 – IEEE Std 802.1CB-2017 feature selection .....	78
Table 117 – IEEE Std 802.1Q-2018 feature selection.....	79
Table 118 – Cut through feature selection.....	80
Table 119 – Wireless feature selection .....	80
Table 120 – Node classes for network component .....	80
Table 121 – Conformance class constraints – wireline .....	81
Table 122 – Conformance class constraints – wireless .....	81
Table 123 – CP 3/4: AL service selection for an IO device .....	83
Table 124 – CP 3/4: Additional AL service selection for an IO controller .....	86
Table 125 – CP 3/4: Additional AL service selection for an IO supervisor.....	86
Table 126 – CP 3/4: AL protocol selection for an IO device.....	87
Table 127 – CP 3/4: AL protocol selection for an IO controller .....	89
Table 128 – CP 3/4, CP 3/5, CP 3/6 and CP 3/7: performance indicator overview .....	92

Table 129 – CP 3/4, CP 3/5, CP 3/6 and CP 3/7: performance indicator dependency matrix .....	93
Table 130 – Media Redundancy Manager (MRM) parameters .....	96
Table 131 – Media Redundancy Client (MRC) parameters .....	97
Table 132 – Media redundancy Interconnection Manager (MIM) parameters .....	97
Table 133 – Media redundancy Interconnection Client (MIC) parameters .....	97
Table 134 – CP 3/4: Consistent set of PI for MinDeviceInterval=128 ms .....	98
Table 135 – CP 3/4: Assumed values for consistent set of PI calculation .....	99
Table 136 – CP 3/5: AL service selection for an IO device .....	100
Table 137 – CP 3/5: Additional AL service selection for an IO controller .....	102
Table 138 – CP 3/5: Additional AL service selection for an IO supervisor .....	102
Table 139 – CP 3/5: AL protocol selection for an IO device .....	103
Table 140 – CP 3/5: AL protocol selection for an IO controller .....	105
Table 141 – CP 3/5: Consistent set of PI for MinDeviceInterval=128 ms .....	108
Table 142 – CP 3/5: Assumed values for consistent set of PI calculation .....	109
Table 143 – CP 3/6: AL service selection for an IO device .....	110
Table 144 – CP 3/6: Additional AL service selection for an IO controller .....	112
Table 145 – CP 3/6: AL protocol selection for an IO device .....	113
Table 146 – CP 3/6: AL protocol selection for an IO controller .....	116
Table 147 – CP 3/6: Consistent set of PI for MinDeviceInterval = 1 ms and NumberOfSwitches = 20 .....	119
Table 148 – CP 3/6: Consistent set of PI for MinDeviceInterval = 1 ms and NumberOfSwitches = 63 .....	119
Table 149 – CP 3/6: Assumed values for consistent set of PI calculation .....	120
Table 150 – CP 3/6: Consistent set of PI for MinDeviceInterval = 31,25 µs and NumberOfSwitches = 10 .....	121
Table 151 – CP 3/6: Assumed values for consistent set of PI calculation .....	121
Table 152 – CP 3/7: AL service selection for an IO device .....	122
Table 153 – CP 3/7: Additional AL service selection for an IO controller .....	124
Table 154 – CP 3/7: AL protocol selection for an IO device .....	125
Table 155 – CP 3/7: AL protocol selection for an IO controller .....	127
Table 156 – CP 3/7: Consistent set of PI for MinDeviceInterval = 1 ms and NumberOfSwitches = 20 .....	130
Table 157 – CP 3/7: Consistent set of PI for MinDeviceInterval = 1 ms and NumberOfSwitches = 63 .....	131
Table 158 – CP 3/7: Assumed values for consistent set of PI calculation .....	131
Table 159 – CP 3/7: Consistent set of PI for MinDeviceInterval = 31,25 µs and NumberOfSwitches = 10 .....	132
Table 160 – CP 3/7: Assumed values for consistent set of PI calculation .....	133

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**INDUSTRIAL NETWORKS –  
PROFILES –****Part 2-3: Additional real-time fieldbus profiles  
based on ISO/IEC/IEEE 8802-3 –  
CPF 3**

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IEC 61784-2-3 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This first edition, together with the other parts of the same series, cancels and replaces the fourth edition of IEC 61784-2 published in 2019. This first edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC 61784-2:2019:

- a) split of the original IEC 61784-2 into several subparts, one subpart for the material of a generic nature, and one subpart for each Communication Profile Family specified in the original document;
- b) addition of new profile CP 3/7;
- c) update of the requirements for all conformance classes;
- d) updated timing requirements for IO devices;
- e) refining the added application classes.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65C/1209/FDIS	65C/1237/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/publications](http://www.iec.ch/publications).

A list of all parts of the IEC 61784-2 series, published under the general title *Industrial networks – Profiles – Part 2: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3*, can be found on the IEC website.

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## INTRODUCTION

The IEC 61784-2 series provides additional Communication Profiles (CP) to the existing Communication Profile Families (CPF) of the IEC 61784-1 series and additional CPFs with one or more CPs. These profiles meet the industrial automation market objective of identifying Real-Time Ethernet (RTE) communication networks coexisting with ISO/IEC/IEEE 8802-3 – commonly known as Ethernet. These RTE communication networks use provisions of ISO/IEC/IEEE 8802-3 for the lower communication stack layers and additionally provide more predictable and reliable real-time data transfer and means for support of precise synchronization of automation equipment.

More specifically, these profiles help to correctly state the compliance of RTE communication networks with ISO/IEC/IEEE 8802-3, and to avoid the spreading of divergent implementations.

Adoption of Ethernet technology for industrial communication between controllers and even for communication with field devices promotes the use of Internet technologies in the field area. This availability would be unacceptable if it causes the loss of features required in the field area for industrial communication automation networks, such as:

- real-time,
- synchronized actions between field devices like drives,
- efficient, frequent exchange of very small data records.

These new RTE profiles can take advantage of the improvements of Ethernet networks in terms of transmission bandwidth and network span.

Another implicit but essential requirement is that the typical Ethernet communication capabilities, as used in the office world, are fully retained, so that the software involved remains applicable.

The market is in need of several network solutions, each with different performance characteristics and functional capabilities, matching the diverse application requirements. RTE performance indicators, whose values will be provided with RTE devices based on communication profiles specified in the IEC 61784-2 series, enable the user to match network devices with application-dependent performance requirements of an RTE network.

## INDUSTRIAL NETWORKS – PROFILES –

### Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – CPF 3

#### 1 Scope

This part of IEC 61784-2 defines extensions of Communication Profile Family 3 (CPF 3) for Real-Time Ethernet (RTE). CPF 3 specifies a set of Real-Time Ethernet (RTE) communication profiles (CPs) and related network components based on the IEC 61158 series (Type 10), ISO/IEC/IEEE 8802-3 and other standards.

For each RTE communication profile, this document also specifies the relevant RTE performance indicators and the dependencies between these RTE performance indicators.

NOTE 1 All CPs are based on standards or draft standards or International Standards published by the IEC or on standards or International Standards established by other standards bodies or open standards processes.

NOTE 2 The RTE communication profiles use ISO/IEC/IEEE 8802-3 communication networks and its related network components and in some cases amend those standards to obtain RTE features.

NOTE 3 Some CPs of CPF 3 are specified in IEC 61784-1-3.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE All parts of the IEC 61158 series, as well as the IEC 61784-1 series and the IEC 61784-2 series, are maintained simultaneously. Cross-references to these documents within the text therefore refer to the editions as dated in this list of normative references.

IEC 61158 (all parts), *Industrial communication networks – Fieldbus specifications*

IEC 61158-5-10:2023, *Industrial communication networks – Fieldbus specifications – Part 5-10: Application layer service definition – Type 10 elements*

IEC 61158-6-10:2023, *Industrial communication networks – Fieldbus specifications – Part 6-10: Application layer protocol specification – Type 10 elements*

IEC 61784-1-3:2023, *Industrial networks – Profiles – Part 1-3: Fieldbus profiles – Communication Profile Family 3*

IEC 61784-2-0:2023, *Industrial networks – Profiles – Part 2-0: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 – General concepts and terminology*

IEC 61784-3-3:2021, *Industrial communication networks – Profiles – Part 3-3: Functional safety fieldbuses – Additional specifications for CPF 3*

IEC 61784-5-3:2018, *Industrial communication networks – Profiles – Part 5-3: Installation of fieldbuses – Installation profiles for CPF 3*